

## Change of Address

### HONG LEONG INDUSTRIES BERHAD

<b>Change description</b>	REGISTERED
<b>Old address</b>	Level 9, Wisma Hong Leong 18 Jalan Perak 50450 Kuala Lumpur Wilayah Persekutuan Malaysia
<b>New address</b>	Level 31, Menara Hong Leong No. 6, Jalan Damanlela, Bukit Damansara 50490 Kuala Lumpur Wilayah Persekutuan Malaysia
<b>Telephone No</b>	03 -20809200 -89258
<b>Facsimile No</b>	03 -20809238
<b>E-mail address</b>	
<b>Effective date</b>	02 Jul 2018

<b>Change description</b>	CORRESPONDENCE
<b>Old address</b>	Level 9, Wisma Hong Leong 18 Jalan Perak 50450 Kuala Lumpur Wilayah Persekutuan Malaysia
<b>New address</b>	Level 31, Menara Hong Leong No. 6, Jalan Damanlela, Bukit Damansara 50490 Kuala Lumpur Wilayah Persekutuan Malaysia
<b>Telephone No</b>	03 -20809200 -89258
<b>Facsimile No</b>	03 -20809238
<b>E-mail address</b>	
<b>Effective date</b>	02 Jul 2018

---

#### Announcement Info

<b>Company Name</b>	HONG LEONG INDUSTRIES BERHAD
<b>Stock Name</b>	HLIND
<b>Date Announced</b>	28 Jun 2018
<b>Category</b>	Change of Address
<b>Reference Number</b>	C01-28062018-00003